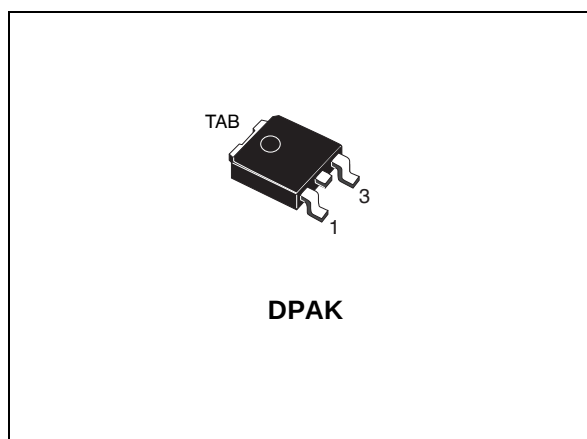


## Automotive-grade 10 A, 600 V, short-circuit rugged IGBT with Ultrafast diode

Datasheet - production data



### Features

- Designed for automotive applications and AEC-Q101 qualified
- Low on-voltage drop ( $V_{CE(sat)}$ )
- Low  $C_{res} / C_{ies}$  ratio (no cross conduction susceptibility)
- Switching losses include diode recovery energy
- Short-circuit rated
- Very soft Ultrafast recovery anti-parallel diode

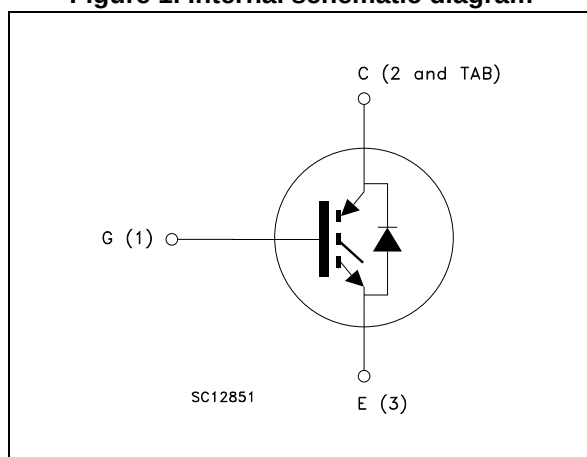
### Applications

- High frequency inverters
- SMPS and PFC in both hard switch and resonant topologies
- Motor drives
- Injection systems

### Description

This device utilizes the advanced PowerMESH™ process for the IGBT and the Turbo 2 Ultrafast high voltage technology for the diode. The combination results in a very good trade-off between conduction losses and switching behavior rendering the product ideal for diverse high voltage applications operating at high frequencies.

**Figure 1. Internal schematic diagram**



**Table 1. Device summary**

| Order code   | Marking    | Package | Packaging     |
|--------------|------------|---------|---------------|
| STGD10HF60KD | GD10HF60KD | DPAK    | Tape and reel |

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# 1 Electrical ratings

$T_{CASE} = 25\text{ °C}$  unless otherwise specified.

**Table 2. Absolute maximum ratings**

| Symbol         | Parameter                                                                                                | Value          | Unit               |
|----------------|----------------------------------------------------------------------------------------------------------|----------------|--------------------|
| $V_{CES}$      | Collector-emitter voltage ( $V_{GE} = 0$ )                                                               | 600            | V                  |
| $I_C^{(1)}$    | Collector current (continuous) at $T_C = 25\text{ °C}$                                                   | 18             | A                  |
| $I_C^{(1)}$    | Collector current (continuous) at $T_C = 100\text{ °C}$                                                  | 10             | A                  |
| $I_{CL}^{(2)}$ | Turn-off latching current                                                                                | 30             | A                  |
| $I_{CP}^{(3)}$ | Pulsed collector current                                                                                 | 30             | A                  |
| $V_{GE}$       | Gate-emitter voltage                                                                                     | $\pm 20$       | V                  |
| $V_{GEM}$      | Gate-emitter voltage pulsed ( $t_p \leq 1\text{ ms}$ )                                                   | $\pm 30$       | V                  |
| $I_F$          | Diode RMS forward current                                                                                | 7              | A                  |
| $I_{FSM}$      | Surge non repetitive forward current $t_p = 10\text{ ms}$ sinusoidal                                     | 20             | A                  |
| $P_{TOT}$      | Total dissipation                                                                                        | 62.5           | W                  |
| $t_{scw}$      | Short circuit withstand time ( $V_{CE} = 50\text{ V}$ , $V_{GE} = 15\text{ V}$ , $T_C = 150\text{ °C}$ ) | 10             | $\mu s$            |
| $T_j$          | IGBT operating junction temperature                                                                      | $-55$ to $150$ | $^{\circ}\text{C}$ |
|                | Diode operating junction temperature                                                                     | $-55$ to $175$ | $^{\circ}\text{C}$ |
| $T_{stg}$      | Storage temperature                                                                                      | $-65$ to $150$ | $^{\circ}\text{C}$ |

1. Calculated according to the iterative formula:

$$I_C(T_C) = \frac{T_{j(max)} - T_C}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_C(T_C))}$$

2.  $V_{clamp} = 80\%$  of  $V_{CES}$ ,  $T_j = 150\text{ °C}$ ,  $R_G = 10\text{ }\Omega$ ,  $V_{GE} = 15\text{ V}$   
 3. Pulse width limited by max. junction temperature allowed

**Table 3. Thermal data**

| Symbol         | Parameter                              | Value | Unit                 |
|----------------|----------------------------------------|-------|----------------------|
| $R_{thj-case}$ | Thermal resistance junction-case IGBT  | 2     | $^{\circ}\text{C/W}$ |
| $R_{thj-case}$ | Thermal resistance junction-case diode | 5.8   | $^{\circ}\text{C/W}$ |
| $R_{thj-amb}$  | Thermal resistance junction-ambient    | 100   | $^{\circ}\text{C/W}$ |

## 2 Electrical characteristics

$T_{CASE}=25\text{ }^{\circ}\text{C}$  unless otherwise specified.

**Table 4. Static**

| Symbol        | Parameter                                          | Test conditions                                                                                | Min. | Typ. | Max.                 | Unit                |
|---------------|----------------------------------------------------|------------------------------------------------------------------------------------------------|------|------|----------------------|---------------------|
| $V_{(BR)CES}$ | Collector-emitter breakdown voltage ( $V_{GE}=0$ ) | $I_C = 1\text{ mA}$ , $T_C = -40\text{ }^{\circ}\text{C}$ <sup>(1)</sup>                       | 600  | 610  |                      | V                   |
|               |                                                    | $I_C = 1\text{ mA}$                                                                            |      | 650  |                      | V                   |
|               |                                                    | $I_C = 1\text{ mA}$ , $T_C = 150\text{ }^{\circ}\text{C}$                                      |      | 700  |                      | V                   |
| $I_{GES}$     | Gate-emitter leakage current ( $V_{CE}=0$ )        | $V_{GE} = \pm 20\text{ V}$<br>$V_{GE} = \pm 20\text{ V}$ , $T_C = 150\text{ }^{\circ}\text{C}$ |      |      | $\pm 100$<br>$\pm 1$ | nA<br>$\mu\text{A}$ |
| $I_{CES}$     | Collector cut-off current ( $V_{GE}=0$ )           | $V_{CE} = 600\text{ V}$<br>$V_{CE} = 600\text{ V}$ , $T_C = 150\text{ }^{\circ}\text{C}$       |      |      | 150<br>1             | $\mu\text{A}$<br>mA |
| $V_{GE(th)}$  | Gate threshold voltage                             | $V_{CE} = V_{GE}$ , $I_C = 250\text{ }\mu\text{A}$                                             | 4.5  |      | 6.5                  | V                   |
| $V_{CE(sat)}$ | Collector-emitter saturation voltage               | $V_{GE} = 15\text{ V}$ , $I_C = 5\text{ A}$                                                    | 1.75 |      | 2.75                 | V                   |

1. Value guaranteed by design

**Table 5. Dynamic <sup>(1)</sup>**

| Symbol    | Parameter                    | Test conditions                                                          | Min. | Typ. | Max. | Unit |
|-----------|------------------------------|--------------------------------------------------------------------------|------|------|------|------|
| $C_{ies}$ | Input capacitance            | $V_{CE} = 25\text{ V}$ , $f = 1\text{ MHz}$ , $V_{GE}=0$                 | -    | 430  | -    | pF   |
| $C_{oes}$ | Output capacitance           |                                                                          | -    | 45   | -    | pF   |
| $C_{res}$ | Reverse transfer capacitance |                                                                          | -    | 10   | -    | pF   |
| $Q_g$     | Total gate charge            | $V_{CE} = 400\text{ V}$ , $I_C = 5\text{ A}$ ,<br>$V_{GE} = 15\text{ V}$ | -    | 23   | -    | nC   |
| $Q_{ge}$  | Gate-emitter charge          |                                                                          | -    | 4    | -    | nC   |
| $Q_{gc}$  | Gate-collector charge        |                                                                          | -    | 11   | -    | nC   |

1. Values guaranteed by design

Table 6. Switching on/off (inductive load) <sup>(1)</sup>

| Symbol         | Parameter             | Test conditions                                                                                                                       | Min. | Typ. | Max. | Unit       |
|----------------|-----------------------|---------------------------------------------------------------------------------------------------------------------------------------|------|------|------|------------|
| $t_{d(on)}$    | Turn-on delay time    | $V_{CC} = 400\text{ V}$ , $I_C = 5\text{ A}$<br>$R_G = 10\ \Omega$ , $V_{GE} = 15\text{ V}$                                           | -    | 9.5  | -    | ns         |
| $t_r$          | Current rise time     |                                                                                                                                       | -    | 4.4  | -    | ns         |
| $(di/dt)_{on}$ | Turn-on current slope |                                                                                                                                       |      | 930  |      | A/ $\mu$ s |
| $t_{d(on)}$    | Turn-on delay time    | $V_{CC} = 400\text{ V}$ , $I_C = 5\text{ A}$<br>$R_G = 10\ \Omega$ , $V_{GE} = 15\text{ V}$<br>$T_C = 150\text{ }^\circ\text{C}$      | -    | 11   | -    | ns         |
| $t_r$          | Current rise time     |                                                                                                                                       | -    | 4.8  | -    | ns         |
| $(di/dt)_{on}$ | Turn-on current slope |                                                                                                                                       | -    | 904  | -    | A/ $\mu$ s |
| $t_{r(Voff)}$  | Off voltage rise time | $V_{CC} = 400\text{ V}$ , $I_C = 5\text{ A}$ ,<br>$R_{GE} = 10\ \Omega$ , $V_{GE} = 15\text{ V}$                                      | -    | 34   | -    | ns         |
| $t_{d(off)}$   | Turn-off delay time   |                                                                                                                                       | -    | 87   | -    | ns         |
| $t_f$          | Current fall time     |                                                                                                                                       | -    | 100  | -    | ns         |
| $t_{r(Voff)}$  | Off voltage rise time | $V_{CC} = 400\text{ V}$ , $I_C = 5\text{ A}$ ,<br>$R_{GE} = 10\ \Omega$ , $V_{GE} = 15\text{ V}$<br>$T_C = 150\text{ }^\circ\text{C}$ | -    | 83   | -    | ns         |
| $t_{d(off)}$   | Turn-off delay time   |                                                                                                                                       | -    | 93   | -    | ns         |
| $t_f$          | Current fall time     |                                                                                                                                       | -    | 224  | -    | ns         |

1. Value guaranteed by design

Table 7. Switching energy (inductive load) <sup>(1)</sup>

| Symbol          | Parameter                 | Test conditions                                                                                                                  | Min | Typ. | Max | Unit    |
|-----------------|---------------------------|----------------------------------------------------------------------------------------------------------------------------------|-----|------|-----|---------|
| $E_{on}^{(2)}$  | Turn-on switching losses  | $V_{CC} = 400\text{ V}$ , $I_C = 5\text{ A}$<br>$R_G = 10\ \Omega$ , $V_{GE} = 15\text{ V}$                                      | -   | 45   | -   | $\mu$ J |
| $E_{off}^{(3)}$ | Turn-off switching losses |                                                                                                                                  | -   | 105  | -   | $\mu$ J |
| $E_{ts}$        | Total switching losses    |                                                                                                                                  | -   | 150  | -   | $\mu$ J |
| $E_{on}^{(2)}$  | Turn-on switching losses  | $V_{CC} = 400\text{ V}$ , $I_C = 5\text{ A}$<br>$R_G = 10\ \Omega$ , $V_{GE} = 15\text{ V}$<br>$T_C = 150\text{ }^\circ\text{C}$ | -   | 84   | -   | $\mu$ J |
| $E_{off}^{(3)}$ | Turn-off switching losses |                                                                                                                                  | -   | 286  | -   | $\mu$ J |
| $E_{ts}$        | Total switching losses    |                                                                                                                                  | -   | 370  | -   | $\mu$ J |

1. Value guaranteed by design
2. IGBT and diode are at the same temperature
3. Turn-off losses include also the tail of the collector current

Table 8. Collector-emitter diode

| Symbol         | Parameter                | Test conditions                                                                                              | Min | Typ. | Max | Unit |
|----------------|--------------------------|--------------------------------------------------------------------------------------------------------------|-----|------|-----|------|
| $V_F$          | Forward on-voltage       | $I_F = 3\text{ A}$                                                                                           | -   | 1.75 | 2.5 | V    |
|                |                          | $I_F = 3\text{ A}$ , $T_C = 150\text{ °C}$                                                                   | -   | 1.45 |     | V    |
| $t_{rr}^{(1)}$ | Reverse recovery time    | $I_F = 3\text{ A}$ , $V_R = 400\text{ V}$ ,<br>$di/dt = 100\text{ A}/\mu\text{s}$                            | -   | 50   |     | ns   |
| $Q_{rr}^{(1)}$ | Reverse recovery charge  |                                                                                                              | -   | 45   |     | nC   |
| $I_{rm}^{(1)}$ | Reverse recovery current |                                                                                                              | -   | 1.7  |     | A    |
| $t_{rr}^{(1)}$ | Reverse recovery time    | $I_F = 3\text{ A}$ , $V_R = 400\text{ V}$ ,<br>$T_C = 150\text{ °C}$ ,<br>$di/dt = 100\text{ A}/\mu\text{s}$ | -   | 100  |     | ns   |
| $Q_{rr}^{(1)}$ | Reverse recovery charge  |                                                                                                              | -   | 150  |     | nC   |
| $I_{rm}^{(1)}$ | Reverse recovery current |                                                                                                              | -   | 3.1  |     | A    |

1. Limits guaranteed by design

2.1 Electrical characteristics (curves)

Figure 2. Output characteristics ( $T_C = -50^\circ\text{C}$ )

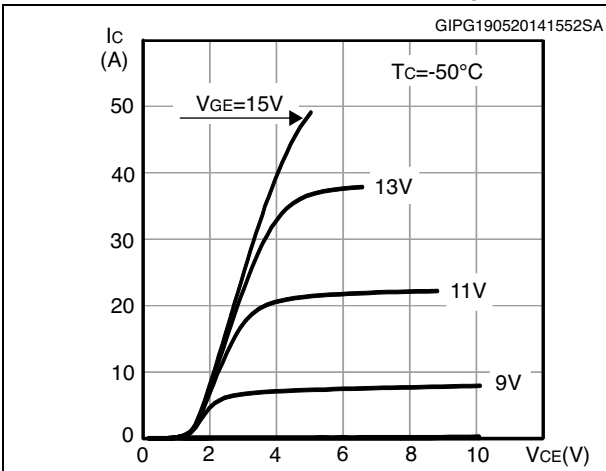


Figure 3. Output characteristics ( $T_C = 25^\circ\text{C}$ )

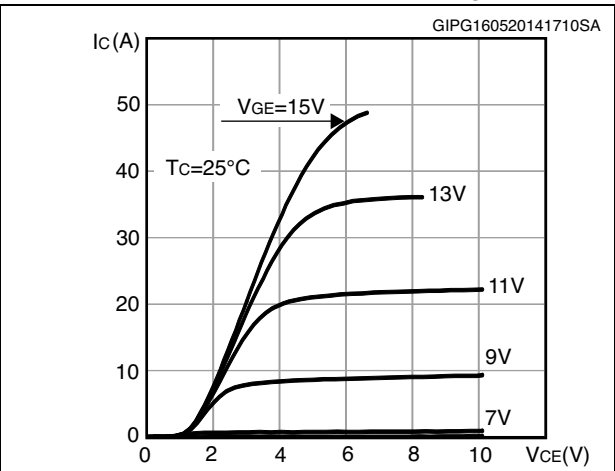


Figure 4. Output characteristics ( $T_C = 150^\circ\text{C}$ )

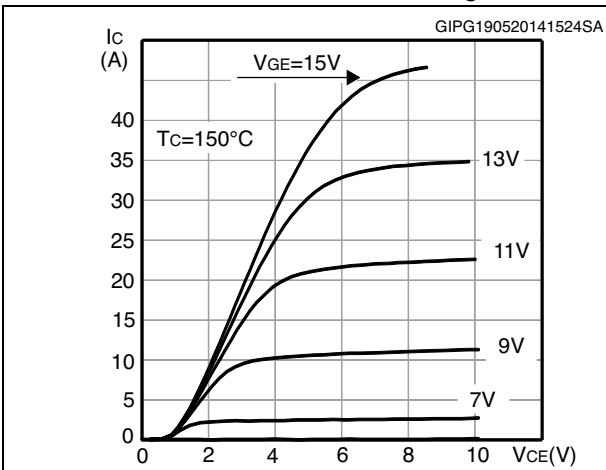


Figure 5. Transfer characteristics

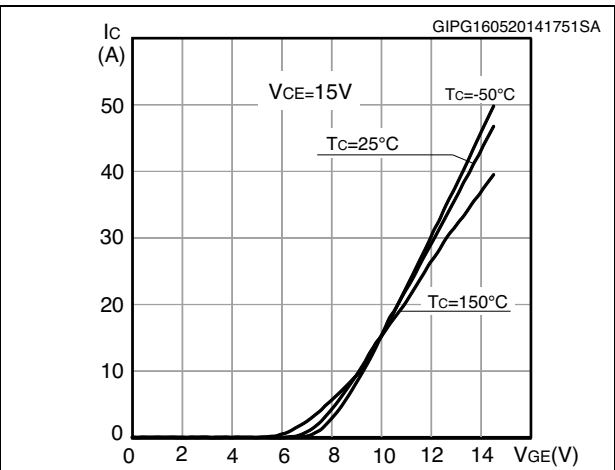


Figure 6. Collector-emitter on voltage vs. collector current

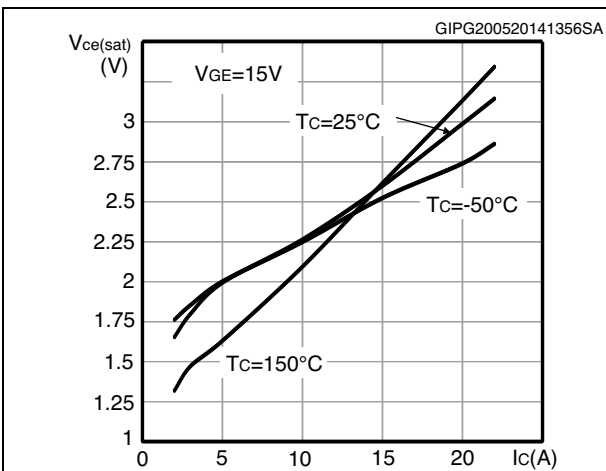


Figure 7. Collector-emitter on voltage vs. temperature

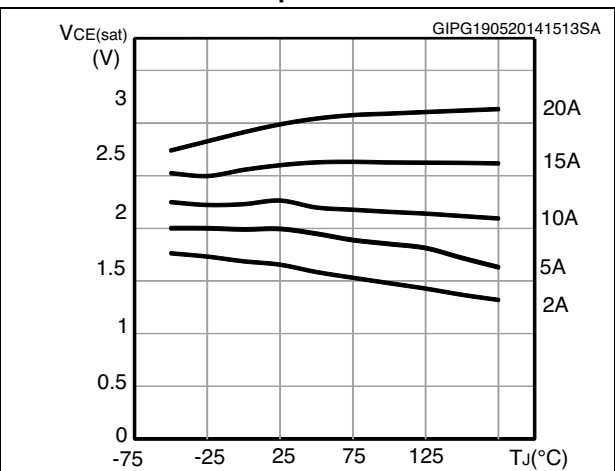


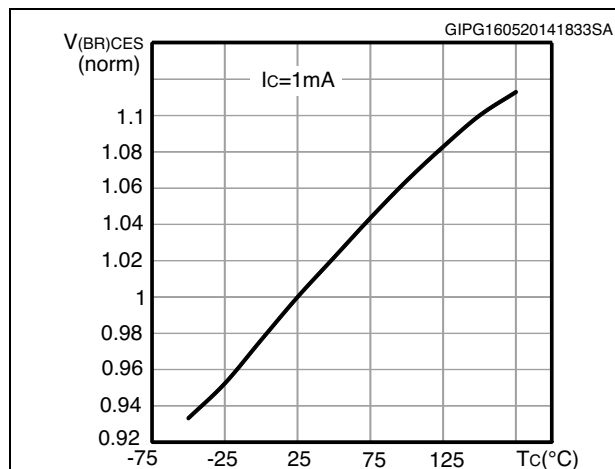
Figure 8. Normalized  $V_{(BR)CES}$  vs. temperature

Figure 9. Normalized gate threshold vs. temperature

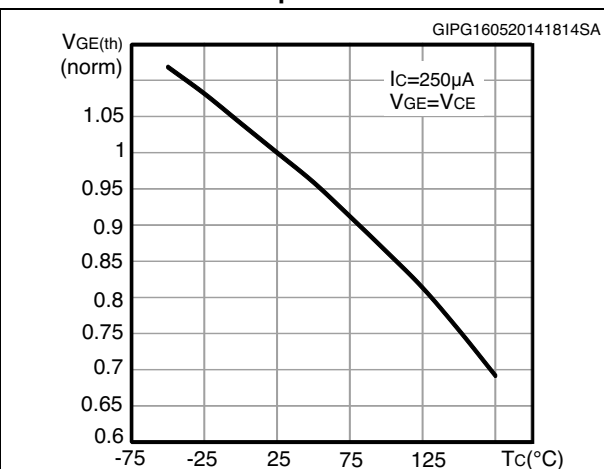


Figure 10. Gate charge vs. gate-emitter voltage

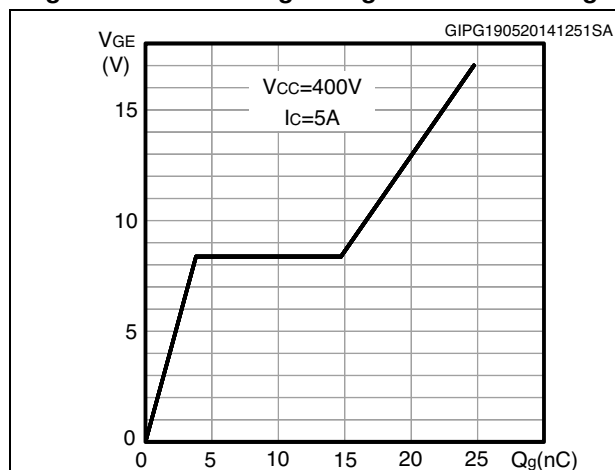


Figure 11. Capacitance variations

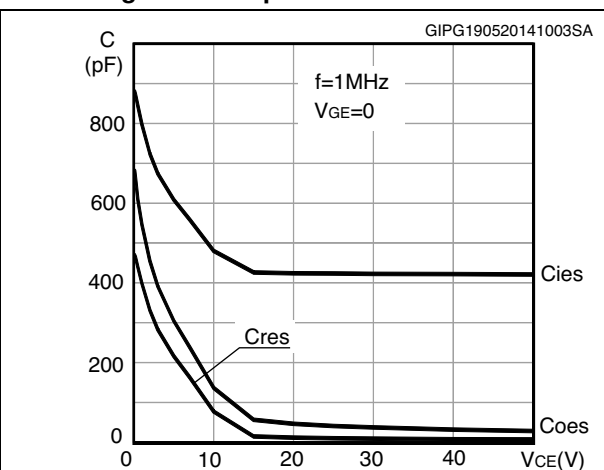


Figure 12. Switching losses vs. temperature

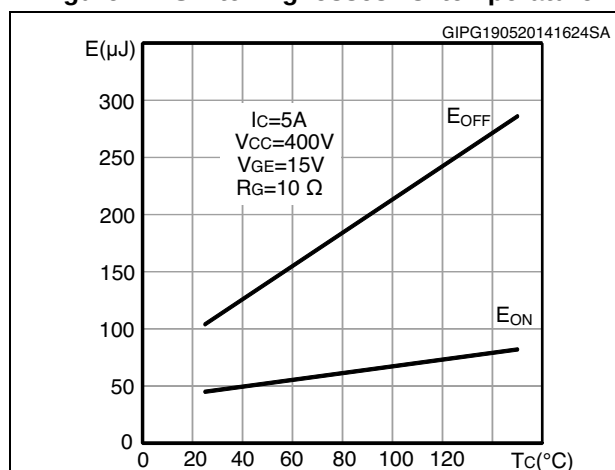


Figure 13. Switching losses vs. gate resistance

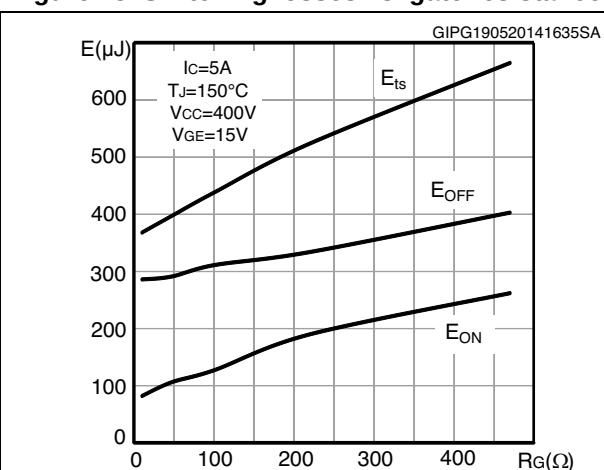




Figure 14. Switching losses vs. collector current

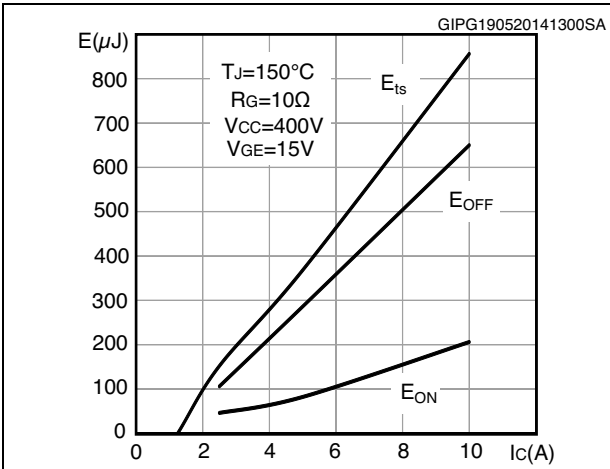


Figure 15. Short-circuit withstand time and current vs. gate-emitter voltage

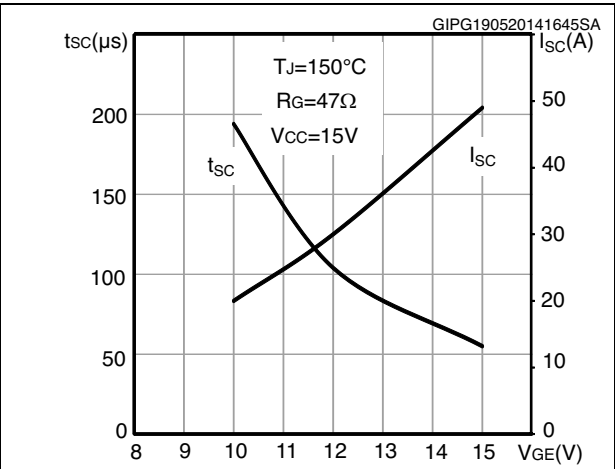


Figure 16. RBSOA

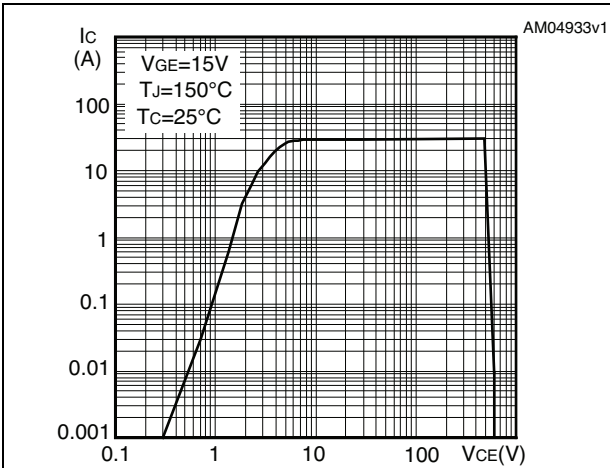


Figure 17. Switching times vs. gate resistance at TJ=25 °C

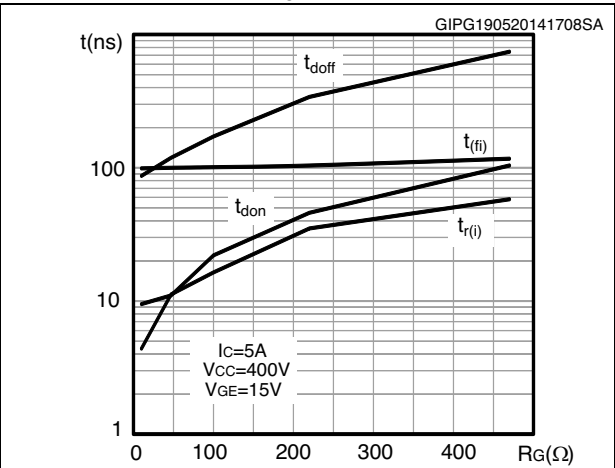


Figure 18. Switching times vs. gate resistance at TJ=150 °C

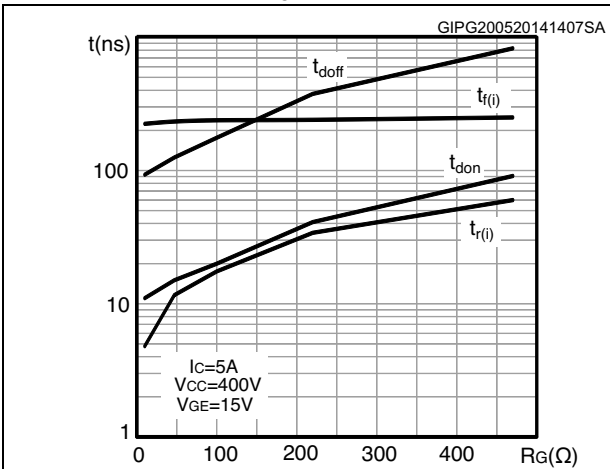


Figure 19. Switching times vs. collector current

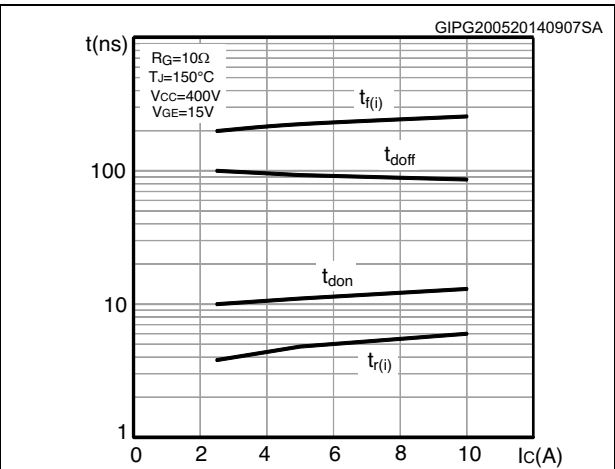


Figure 20. Diode forward voltage drop vs. forward current

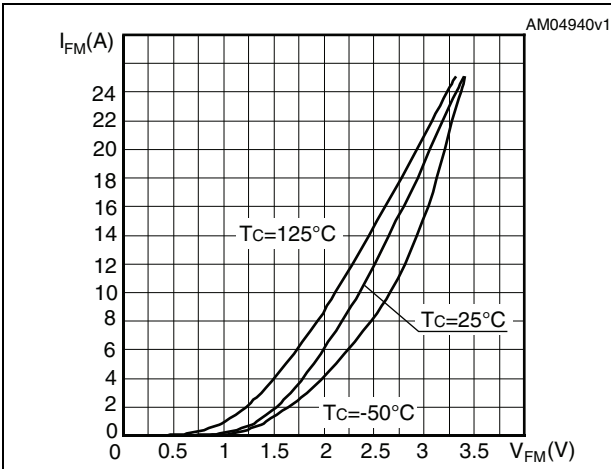


Figure 21. Peak reverse recovery current vs. di/dt

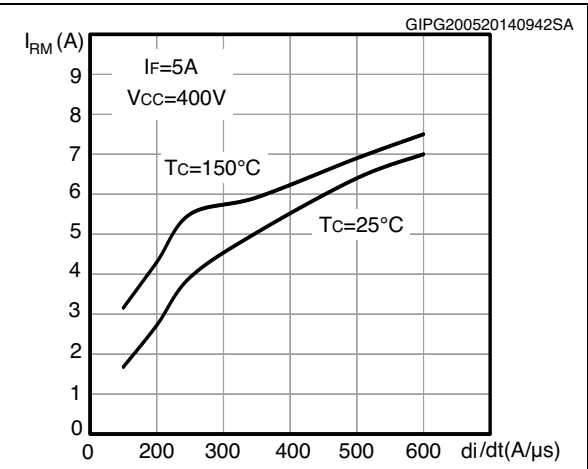


Figure 22. Reverse recovery time vs. di/dt

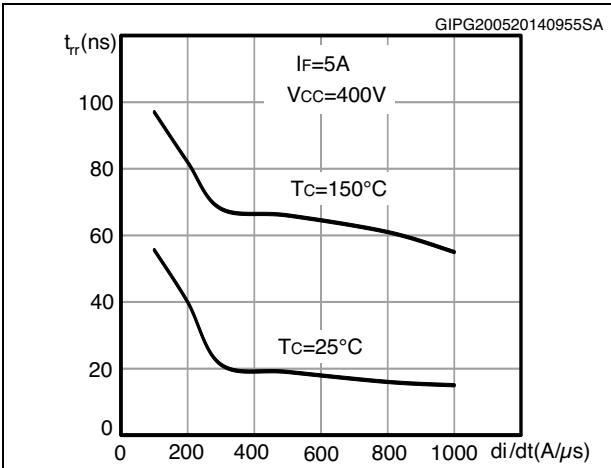


Figure 23. Reverse recovery softness factor vs. di/dt

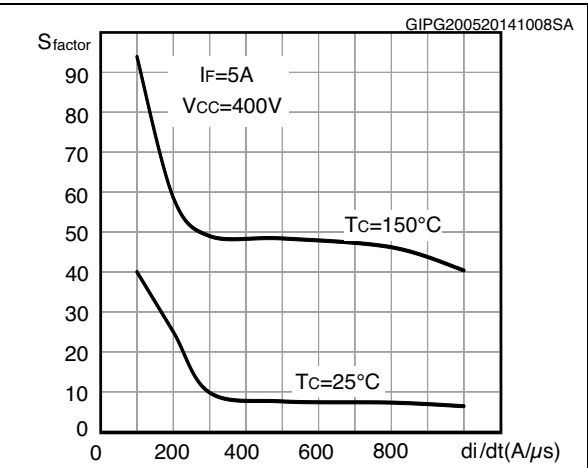


Figure 24. Reverse recovery charges vs. di/dt

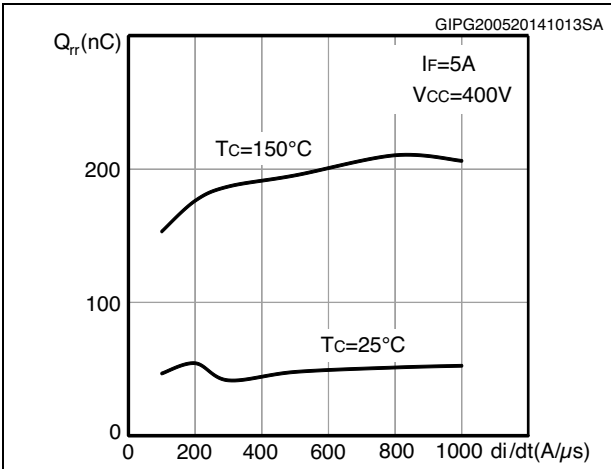


Figure 25. IGBT thermal impedance

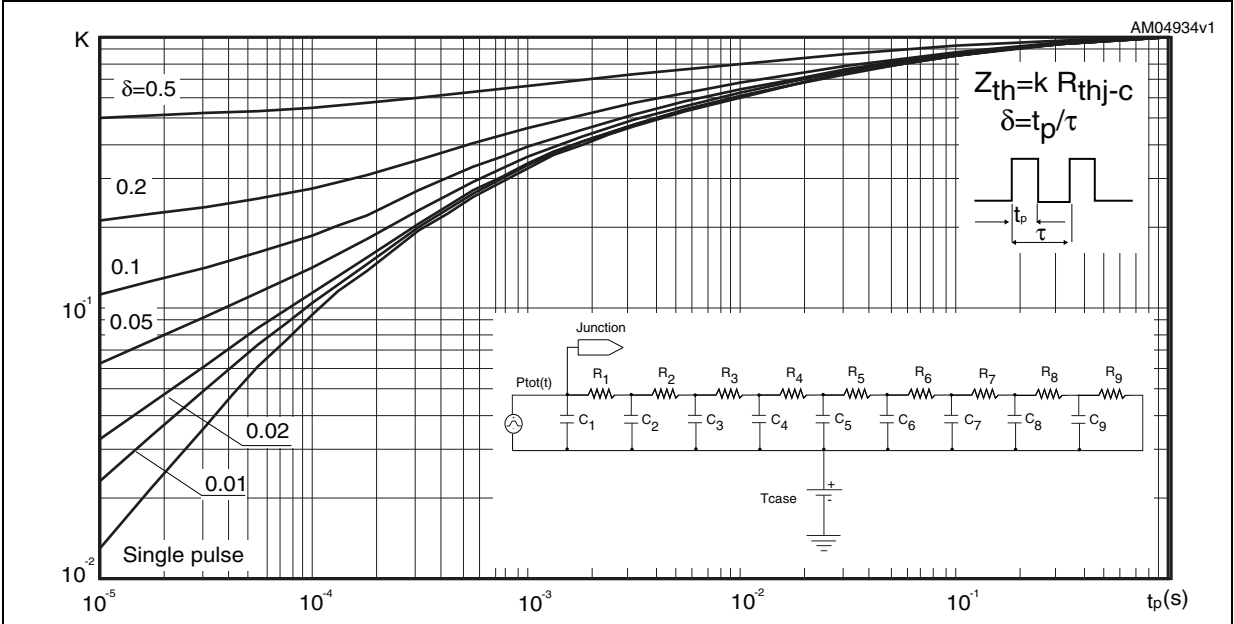


Table 9. IGBT RC-Cauer thermal network

| Symbol | Value  | Unit                        | Symbol | Value    | Unit                                  |
|--------|--------|-----------------------------|--------|----------|---------------------------------------|
| $R_1$  | 0.344  | $^{\circ}\text{C}/\text{W}$ | $C_1$  | 0.4E-3   | $\text{W}^*\text{s}/^{\circ}\text{C}$ |
| $R_2$  | 0.0686 | $^{\circ}\text{C}/\text{W}$ | $C_2$  | 0.162E-4 | $\text{W}^*\text{s}/^{\circ}\text{C}$ |
| $R_3$  | 0.0958 | $^{\circ}\text{C}/\text{W}$ | $C_3$  | 0.684E-3 | $\text{W}^*\text{s}/^{\circ}\text{C}$ |
| $R_4$  | 0.177  | $^{\circ}\text{C}/\text{W}$ | $C_4$  | 0.923E-4 | $\text{W}^*\text{s}/^{\circ}\text{C}$ |
| $R_5$  | 0.250  | $^{\circ}\text{C}/\text{W}$ | $C_5$  | 0.3E-2   | $\text{W}^*\text{s}/^{\circ}\text{C}$ |
| $R_6$  | 0.245  | $^{\circ}\text{C}/\text{W}$ | $C_6$  | 0.9E-2   | $\text{W}^*\text{s}/^{\circ}\text{C}$ |
| $R_7$  | 0.152  | $^{\circ}\text{C}/\text{W}$ | $C_7$  | 0.678E-3 | $\text{W}^*\text{s}/^{\circ}\text{C}$ |
| $R_8$  | 0.135  | $^{\circ}\text{C}/\text{W}$ | $C_8$  | 0.807E-3 | $\text{W}^*\text{s}/^{\circ}\text{C}$ |
| $R_9$  | 0.530  | $^{\circ}\text{C}/\text{W}$ | $C_9$  | 0.248    | $\text{W}^*\text{s}/^{\circ}\text{C}$ |

Figure 26. Diode thermal impedance

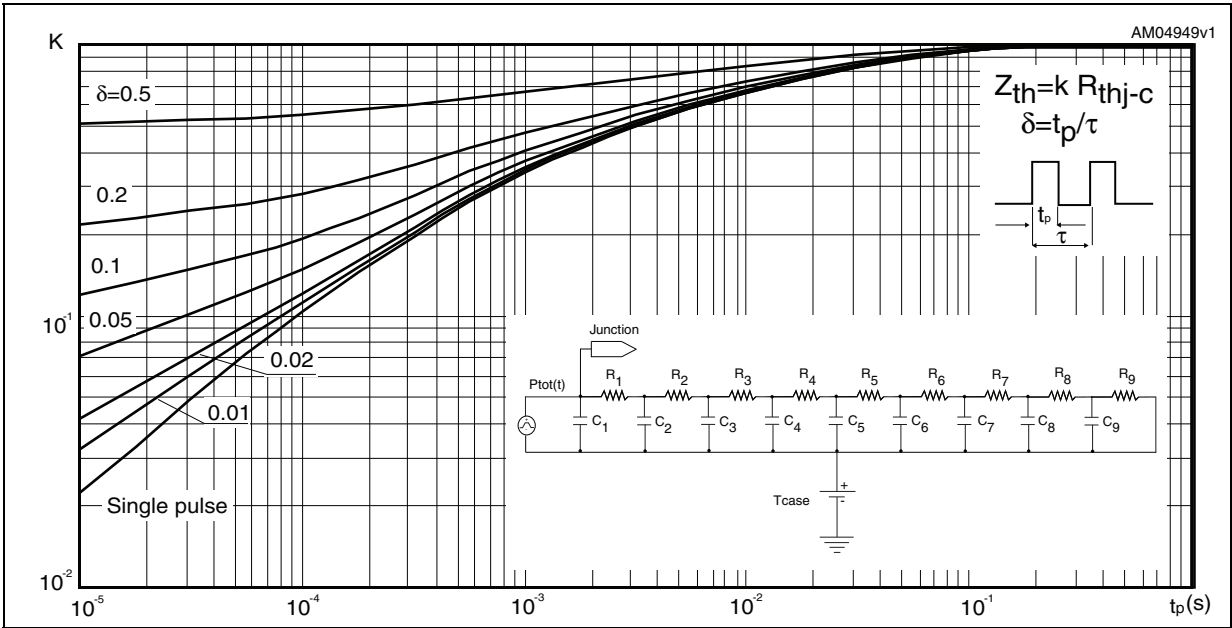


Table 10. Diode RC-Cauer thermal network

| Symbol | Value | Unit                        | Symbol | Value    | Unit                                  |
|--------|-------|-----------------------------|--------|----------|---------------------------------------|
| $R_1$  | 0.478 | $^{\circ}\text{C}/\text{W}$ | $C_1$  | 0.8E-4   | $\text{W}^*\text{s}/^{\circ}\text{C}$ |
| $R_2$  | 0.542 | $^{\circ}\text{C}/\text{W}$ | $C_2$  | 1E-4     | $\text{W}^*\text{s}/^{\circ}\text{C}$ |
| $R_3$  | 0.600 | $^{\circ}\text{C}/\text{W}$ | $C_3$  | 2E-4     | $\text{W}^*\text{s}/^{\circ}\text{C}$ |
| $R_4$  | 0.277 | $^{\circ}\text{C}/\text{W}$ | $C_4$  | 0.5E-5   | $\text{W}^*\text{s}/^{\circ}\text{C}$ |
| $R_5$  | 0.844 | $^{\circ}\text{C}/\text{W}$ | $C_5$  | 0.145E-2 | $\text{W}^*\text{s}/^{\circ}\text{C}$ |
| $R_6$  | 0.313 | $^{\circ}\text{C}/\text{W}$ | $C_6$  | 0.499E-4 | $\text{W}^*\text{s}/^{\circ}\text{C}$ |
| $R_7$  | 0.108 | $^{\circ}\text{C}/\text{W}$ | $C_7$  | 0.727E-3 | $\text{W}^*\text{s}/^{\circ}\text{C}$ |
| $R_8$  | 0.891 | $^{\circ}\text{C}/\text{W}$ | $C_8$  | 0.393E-4 | $\text{W}^*\text{s}/^{\circ}\text{C}$ |
| $R_9$  | 1.73  | $^{\circ}\text{C}/\text{W}$ | $C_9$  | 0.0176   | $\text{W}^*\text{s}/^{\circ}\text{C}$ |

### 3 Test circuits

Figure 27. Test circuit for inductive load switching

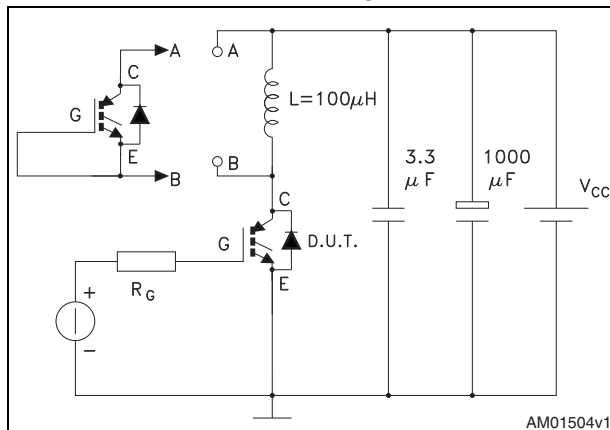


Figure 28. Gate charge test circuit

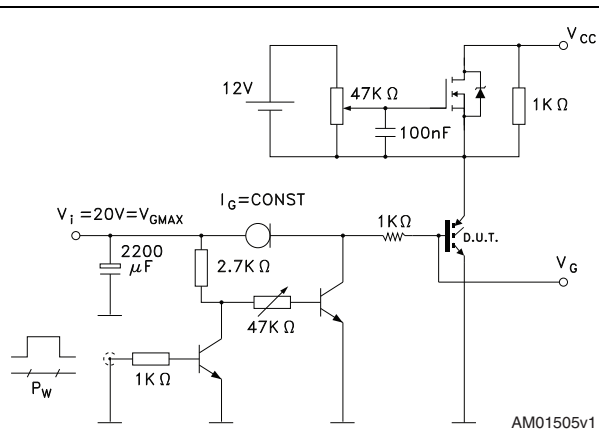


Figure 29. Switching waveforms

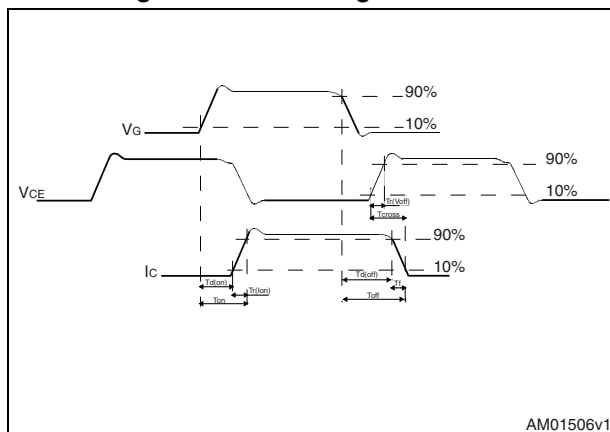
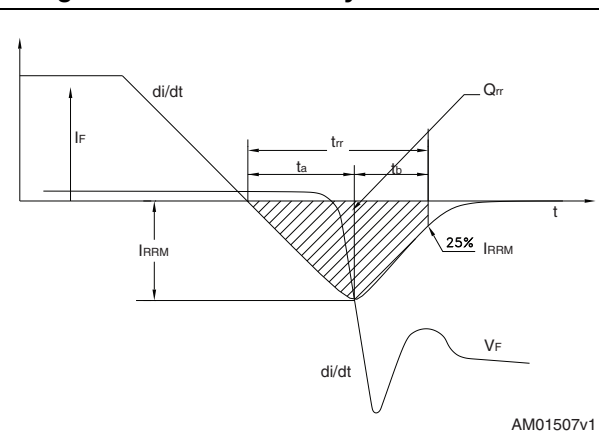


Figure 30. Diode recovery times waveform



## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK<sup>®</sup> is an ST trademark.

Figure 31. DPAK (TO-252) type A drawing

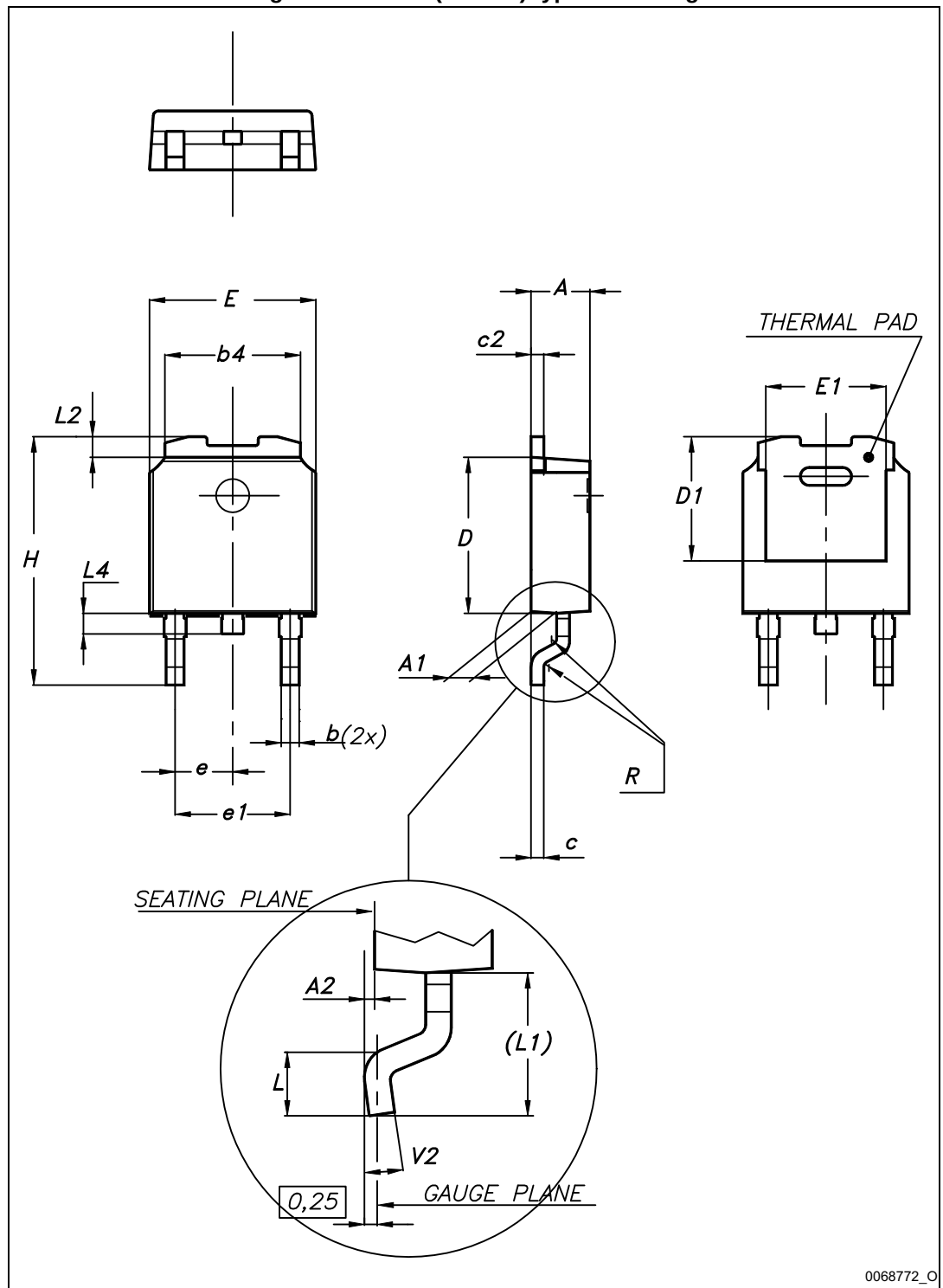
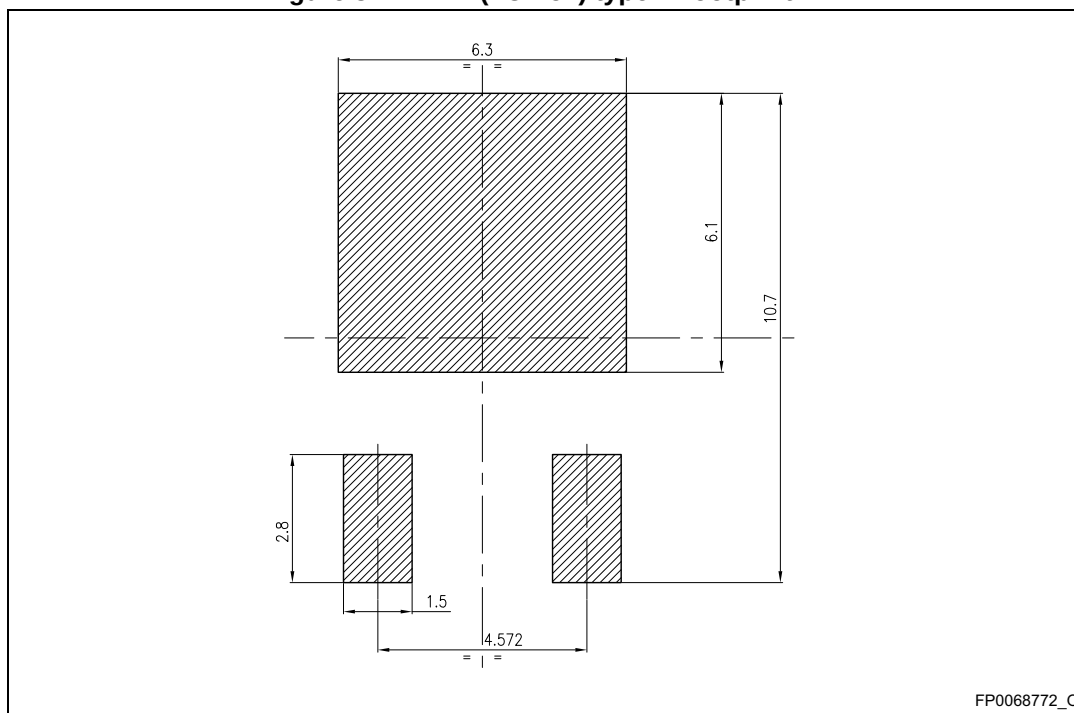


Table 11. DPAK (TO-252) type A mechanical data

| Dim. | mm   |      |       |
|------|------|------|-------|
|      | Min. | Typ. | Max.  |
| A    | 2.20 |      | 2.40  |
| A1   | 0.90 |      | 1.10  |
| A2   | 0.03 |      | 0.23  |
| b    | 0.64 |      | 0.90  |
| b4   | 5.20 |      | 5.40  |
| c    | 0.45 |      | 0.60  |
| c2   | 0.48 |      | 0.60  |
| D    | 6.00 |      | 6.20  |
| D1   |      | 5.10 |       |
| E    | 6.40 |      | 6.60  |
| E1   |      | 4.70 |       |
| e    |      | 2.28 |       |
| e1   | 4.40 |      | 4.60  |
| H    | 9.35 |      | 10.10 |
| L    | 1.00 |      | 1.50  |
| (L1) |      | 2.80 |       |
| L2   |      | 0.80 |       |
| L4   | 0.60 |      | 1.00  |
| R    |      | 0.20 |       |
| V2   | 0°   |      | 8°    |



Figure 32. DPAK (TO-252) type A footprint (a)



a. All dimensions are in millimeters

5      Packaging mechanical data

Figure 33. Tape for DPAK (TO-252)

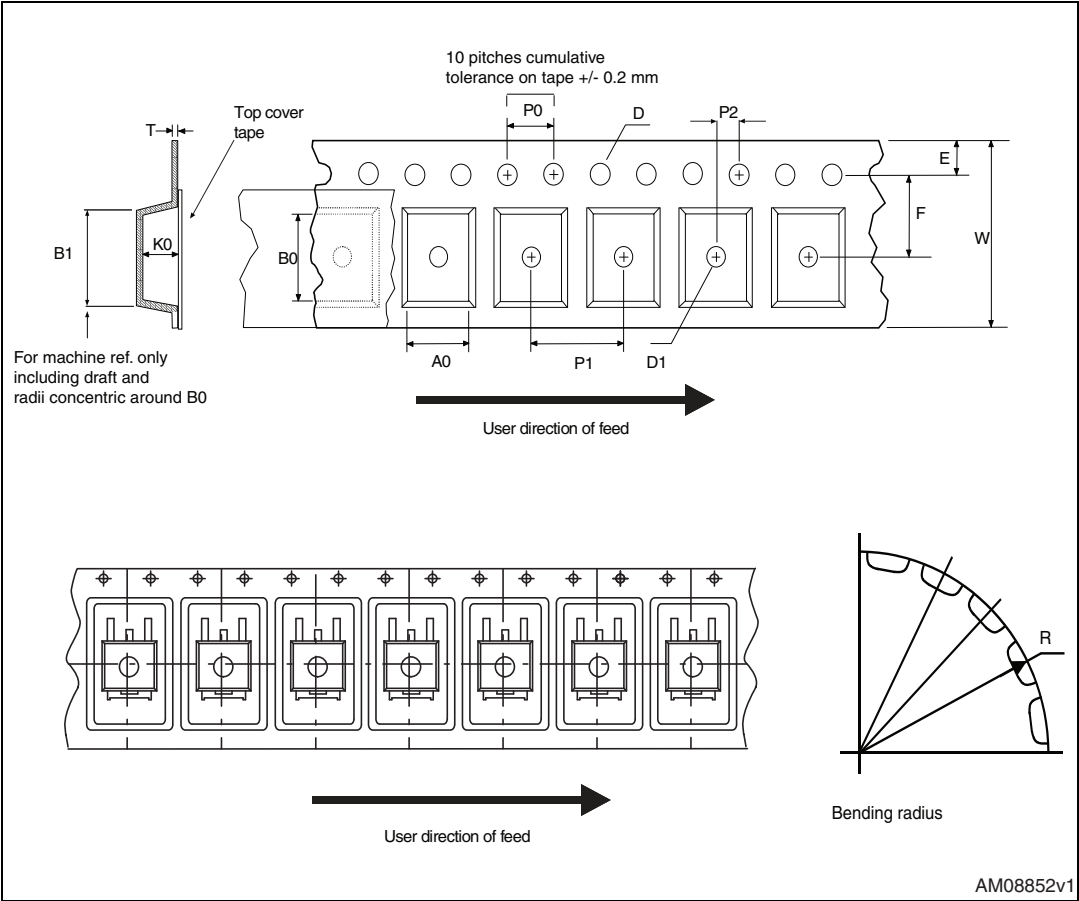


Figure 34. Reel for DPAK (TO-252)

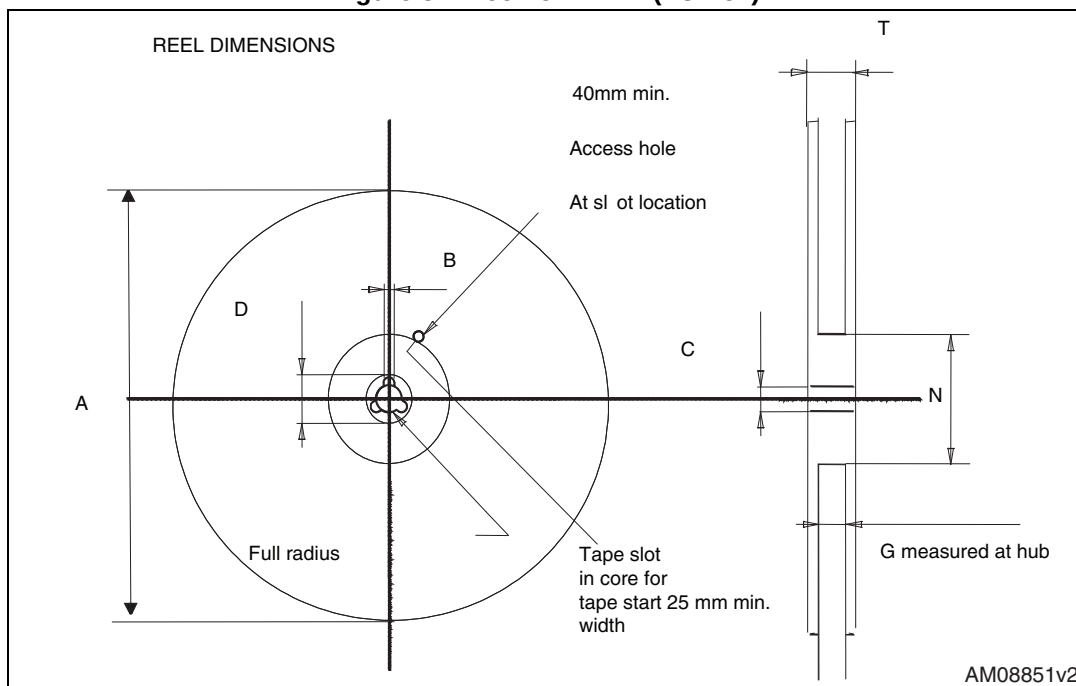


Table 12. DPAK (TO-252) tape and reel mechanical data

| Tape |      |      | Reel      |      |      |
|------|------|------|-----------|------|------|
| Dim. | mm   |      | Dim.      | mm   |      |
|      | Min. | Max. |           | Min. | Max. |
| A0   | 6.8  | 7    | A         |      | 330  |
| B0   | 10.4 | 10.6 | B         | 1.5  |      |
| B1   |      | 12.1 | C         | 12.8 | 13.2 |
| D    | 1.5  | 1.6  | D         | 20.2 |      |
| D1   | 1.5  |      | G         | 16.4 | 18.4 |
| E    | 1.65 | 1.85 | N         | 50   |      |
| F    | 7.4  | 7.6  | T         |      | 22.4 |
| K0   | 2.55 | 2.75 |           |      |      |
| P0   | 3.9  | 4.1  | Base qty. |      | 2500 |
| P1   | 7.9  | 8.1  | Bulk qty. |      | 2500 |
| P2   | 1.9  | 2.1  |           |      |      |
| R    | 40   |      |           |      |      |
| T    | 0.25 | 0.35 |           |      |      |
| W    | 15.7 | 16.3 |           |      |      |

## 6 Revision history

Table 13. Document revision history

| Date        | Revision | Changes                                                                                                                                                                                                                      |
|-------------|----------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 28-Feb-2012 | 1        | First release                                                                                                                                                                                                                |
| 27-May-2014 | 2        | <ul style="list-style-type: none"><li>– Added: <a href="#">Section 2.1: Electrical characteristics (curves)</a></li><li>– Updated: <a href="#">Section 4: Package mechanical data</a></li><li>– Minor text changes</li></ul> |

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